



SURFACE MOUNT SCHOTTKY BARRIER DIODE

Features

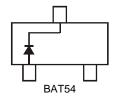
- Low Turn-on Voltage
- Fast Switching
- PN Junction Guard Ring for Transient and ESD Protection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Notes 3 & 4)
- Qualified to AEC-Q101 Standards for High Reliability

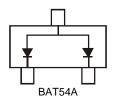
Mechanical Data

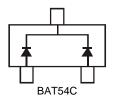
- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagrams Below
- Weight: 0.008 grams (approximate)

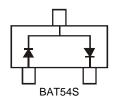


Top View









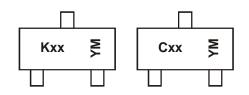
Ordering Information (Note 5)

Part Number	Qualification	Case	Packaging
BAT54-7-F	Commercial	SOT23	3000/Tape & Reel
BAT54A-7-F	Commercial	SOT23	3000/Tape & Reel
BAT54C-7-F	Commercial	SOT23	3000/Tape & Reel
BAT54S-7-F	Commercial	SOT23	3000/Tape & Reel
BAT54Q-7-F	Automotive	SOT23	3000/Tape & Reel
BAT54AQ-7-F	Automotive	SOT23	3000/Tape & Reel
BAT54CQ-7-F	Automotive	SOT23	3000/Tape & Reel
BAT54SQ-7-F	Automotive	SOT23	3000/Tape & Reel
BAT54-13-F	Commercial	SOT23	10,000/Tape & Reel
BAT54A-13-F	Commercial	SOT23	10,000/Tape & Reel
BAT54Q-13	Automotive	SOT23	10,000/Tape & Reel
BAT54AQ-13	Automotive	SOT23	10,000/Tape & Reel
BAT54SQ-13	Automotive	SOT23	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Products manufactured with date code VD (Week 50, 2008) and newer are built with Green Molding Compound. Products manufactured with date code prior to VD are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.
- 5. For packaging details, go to our website at http://www.diodes.com.

Marking Information



K = (SAT,Shangbai Assembly / test site)

C = (CAT/DTC, ChengDu Assembly / test site)

xx = Product Type Marking Code

L1 = BAT54

L2 = BAT54A

L3 = BAT54C

L4 = BAT54S

YM = Date Code Marking

Y = Year (ex: T = 2006)

M = Month (ex: 9 = September)

Date Code Key

Year	1998		2002	2003		2009	2010	2011	2012	2013	2014	2015	2016	2017
Code	J		Ν	Р		W	Х	Υ	Z	Α	В	С	D	Е
Month	Jan	Feb	Ma	ar .	Apr	May	Jun	Jul	Aug	Se	р (Oct	Nov	Dec
Code	1	2	3	3	4	5	6	7	8	9		0	N	D



Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _R wm V _R	30	٧
Forward Continuous Current (Note 6)		I _F	200	mA
Repetitive Peak Forward Current		I _{FRM}	300	mA
Forward Surge Current	@ t < 1.0s	I _{FSM}	600	mA

Thermal Characteristics

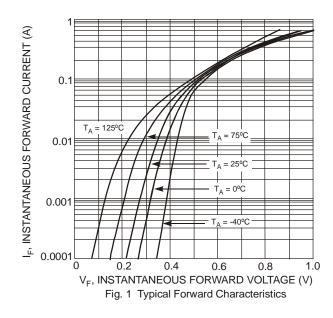
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_{D}	200	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{ heta JA}$	500	°C/W
Operating and Storage Temperature Range (Note 7)	T _J , T _{STG}	-65 to +150	°C

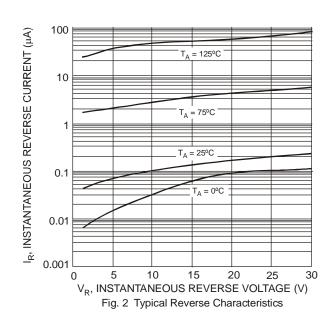
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	$V_{(BR)R}$	30	_	_	V	$I_{RS} = 100 \mu A$
Forward Voltage	VF		_	240 320 400 500 800		I _F = 0.1mA I _F = 1mA I _F = 10mA I _F = 30mA I _F = 100mA
Reverse Leakage Current (Note 8)	I_R		_	2.0	μΑ	$V_R = 25V$
Total Capacitance	Ст		_	10	pF	$V_R = 1.0V, f = 1.0MHz$
Reverse Recovery Time	t _{rr}		_	5.0	ns	$I_F = 10$ mA through $I_R = 10$ mA to $I_R = 1.0$ mA, $R_L = 100$ Ω

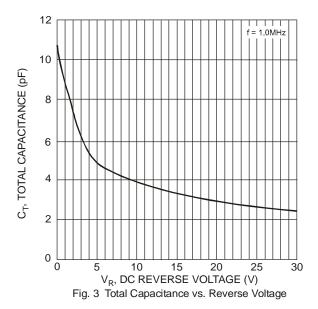
Notes:

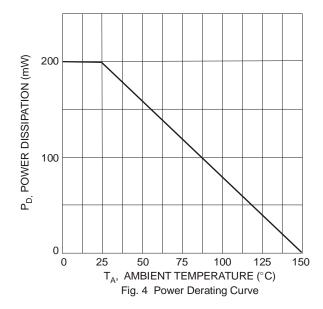
- 6. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com.
- 7. The heat generated must be less than the thermal conductivity from Junction-to-Ambient: $dP_D/dT_J < 1/R_{BJA}$ 8. Short duration test pulse used to minimize self-heating effect.



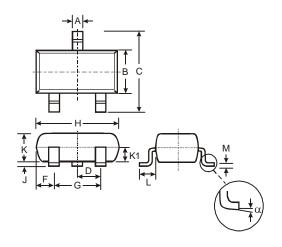






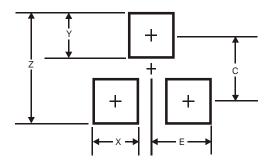


Package Outline Dimensions



SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
7	0.013	0.10	0.05				
K	0.903	1.10	1.00				
K1	-	-	0.400				
L	0.45	0.61	0.55				
М	0.085	0.18	0.11				
α	0°	8°	-				
All Dimensions in mm							

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
С	2.0
E	1.35



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 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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